

/ Descriptions

Silicon PNP transistor in a SOT-23 Plastic Package.

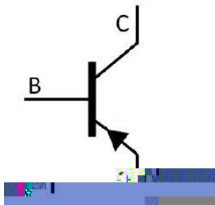
/ Features

Excellent h_{FE} linearity, complementary pair with 2SC1959M.

/ Applications

Audio frequency low power amplifier, driver stage amplifier, switching applications.

/ Equivalent Circuit



/ Pinning



PIN1 Base PIN 2 Emitter PIN 3 Collector

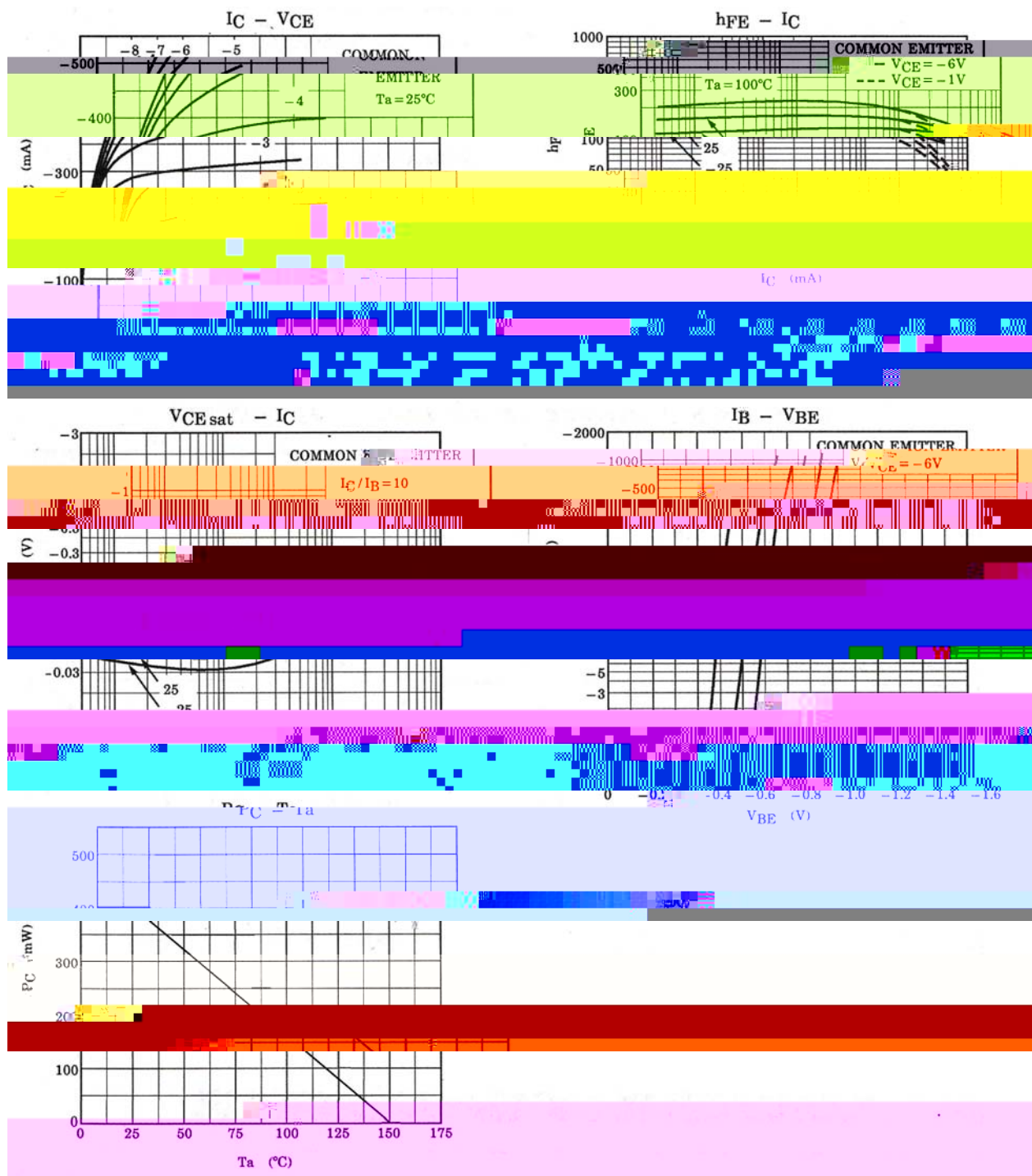
/ h_{FE} Classifications & Marking

h_{FE} Classifications Symbol	O	Y
h_{FE} Range	70 140	120 240
Marking	HVAO	HVAY

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-35	V
Collector to Emitter Voltage	V_{CEO}	-30	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current	I_C	-500	mA
Collector Base	I_B	-100	mA
Collector Power Dissipation	P_C	400	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector Cut-Off Current	I_{CBO}	$V_{CB}=-35V$ $I_E=0$			-0.1	μA
Emitter Base Cut-Off Current	I_{EBO}	$V_{EB}=-5.0V$ $I_C=0$			-0.1	μA
DC Current Gain	$h_{FE(1)}$	$V_{CE}=-1.0V$ $I_C=-100mA$	70		240	
	$h_{FE(2)}$	$V_{CE}=-6.0V$ $I_C=-400mA$	25			
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-100mA$ $I_B=-10mA$		-0.1	-0.25	V
Collector to Base Voltage	V_{BE}	$V_{CE}=-1.0V$ $I_C=-100mA$		-0.8	-1.0	V
Transition Frequency	f_T	$V_{CE}=-6.0V$ $I_C=-20mA$		200		MHz
Collector Output Capacitance	C_{ob}	$V_{CB}=-6.0V$ $I_E=0$ $f=1.0MHz$		13		pF

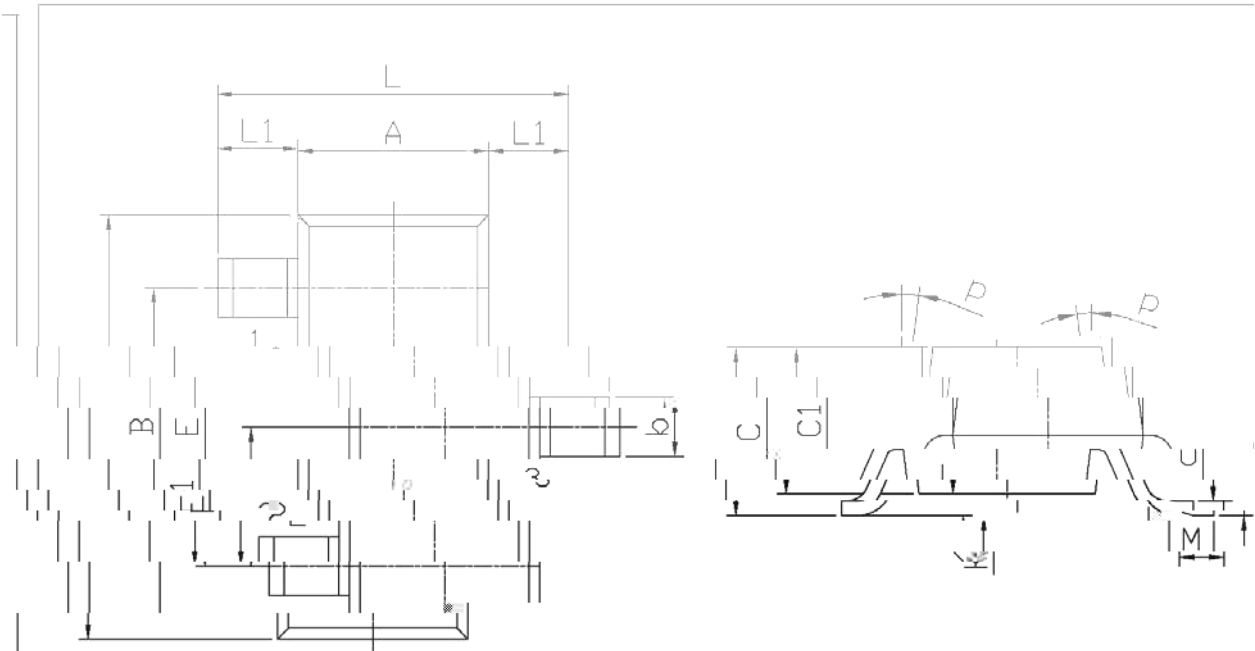
/ Electrical Characteristic Curve



/ Package Dimensions

SOT-23

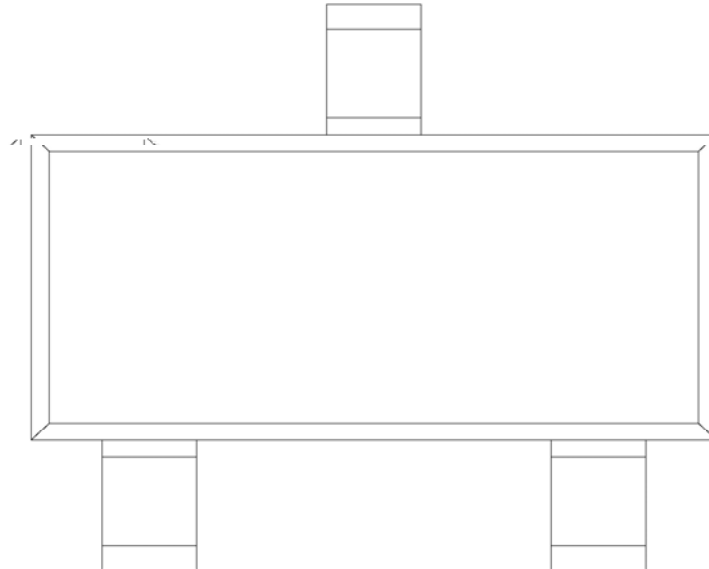
单位: mm



Symbol	Dimensions In Millimeters		Dimensions In Millimeters	
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L	2.95	3.05	L1	0.95
A	0.65	0.75	B	0.95
E	0.45	0.55	b	0.95
P	0.65	0.75	U	0.95
M	0.05	0.15		

/ Marking Instructions

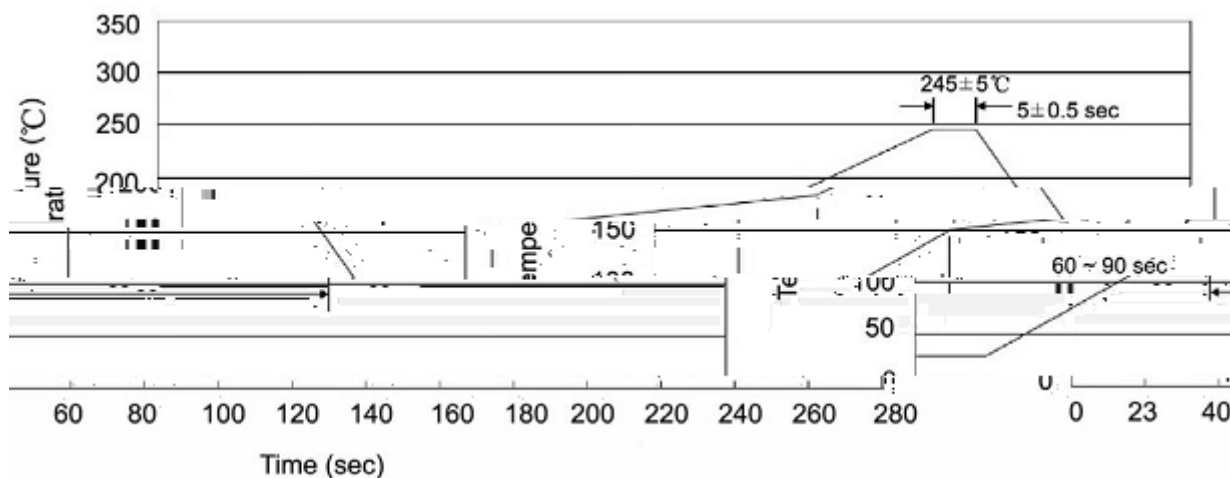


h_{FE}

Note:

H: Company Code.

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Note:

- | | | | | | |
|---|-----|-----|----|---------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 245 | 5 | 5 | 0.5sec; | 2.Peak Temp.:245 5 , Duration:5 0.5sec. |
| 3 | | 2 | 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

260 5 10 1 sec. Temp.:260 5 Time:10 1 sec

/ Packaging SPEC.

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱